

## N-Channel Enhancement Mode MOSFET

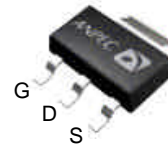
### Features

- 20V/5A,  
 $R_{DS(ON)} = 35m\Omega$  (Typ.) @  $V_{GS} = 10V$   
 $R_{DS(ON)} = 45m\Omega$  (Typ.) @  $V_{GS} = 4.5V$   
 $R_{DS(ON)} = 110m\Omega$  (Typ.) @  $V_{GS} = 2.5V$
- Super High Dense Cell Design
- Reliable and Rugged
- Lead Free and Green Devices Available (RoHS Compliant)

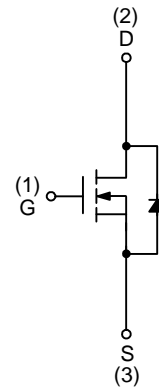
### Applications

- Switching Regulators
- Switching Converters

### Pin Description

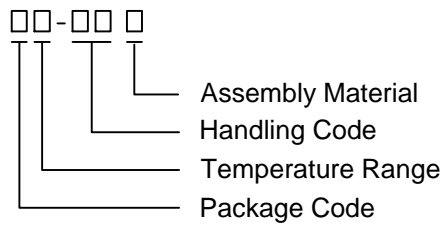


Top View of SOT-223



N-Channel MOSFET

### Ordering and Marking Information

<p>APM2054N □□-□□□</p>  <p>Assembly Material          Handling Code          Temperature Range          Package Code</p>	<p>Package Code          V : SOT-223          Operating Junction Temperature Range          C : -55 to 150 °C          Handling Code          TR : Tape &amp; Reel          Assembly Material          G : Halogen and Lead Free Device</p>
<p>APM2054N V : <span style="border: 1px solid black; padding: 2px;">APM2054N XXXXXX</span></p>	<p>XXXXXX - Date Code</p>

Note: ANPEC lead-free products contain molding compounds/die attach materials and 100% matte tin plate termination finish; which are fully compliant with RoHS. ANPEC lead-free products meet or exceed the lead-free requirements of IPC/JEDEC J-STD-020C for MSL classification at lead-free peak reflow temperature. ANPEC defines "Green" to mean lead-free (RoHS compliant) and halogen free (Br or Cl does not exceed 900ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500ppm by weight).

ANPEC reserves the right to make changes to improve reliability or manufacturability without notice, and advise customers to obtain the latest version of relevant information to verify before placing orders.

## Absolute Maximum Ratings ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Rating	Unit	
$V_{DSS}$	Drain-Source Voltage	20	V	
$V_{GSS}$	Gate-Source Voltage	$\pm 16$		
$I_D^*$	Continuous Drain Current	$V_{GS}=10V$ 5	A	
$I_{DM}^*$	Pulsed Drain Current			20
$I_S^*$	Diode Continuous Forward Current	3	A	
$T_J$	Maximum Junction Temperature	150	$^\circ\text{C}$	
$T_{STG}$	Storage Temperature Range	-55 to 150		
$P_D^*$	Power Dissipation for Single Operation	$T_A=25^\circ\text{C}$	1.47	W
		$T_A=100^\circ\text{C}$	0.58	
$R_{\theta JA}^*$	Thermal Resistance-Junction to Ambient	85	$^\circ\text{C}/\text{W}$	

Note : \*Surface Mounted on 1in<sup>2</sup> pad area, t ≤ 10sec.

## Electrical Characteristics ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Test Conditions	APM2054NV			Unit
			Min.	Typ.	Max.	
<b>STATIC CHARACTERISTICS</b>						
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_{DS}=250\mu\text{A}$	20	-	-	V
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS}=16V, V_{GS}=0V$ $T_J=85^\circ\text{C}$	-	-	1	$\mu\text{A}$
			-	-	30	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_{DS}=250\mu\text{A}$	0.6	0.9	1.5	V
$I_{GSS}$	Gate Leakage Current	$V_{GS}=\pm 16V, V_{DS}=0V$	-	-	$\pm 100$	nA
$R_{DS(ON)}^a$	Drain-Source On-state Resistance	$V_{GS}=10V, I_{DS}=5A$	-	35	40	m $\Omega$
		$V_{GS}=4.5V, I_{DS}=3.5A$	-	45	54	
		$V_{GS}=2.5V, I_{DS}=2.5A$	-	110	130	
$V_{SD}^a$	Diode Forward Voltage	$I_{SD}=3A, V_{GS}=0V$	-	0.85	1.3	V
<b>GATE CHARGE CHARACTERISTICS<sup>b</sup></b>						
$Q_g$	Total Gate Charge	$V_{DS}=10V, V_{GS}=4.5V,$ $I_{DS}=6A$	-	11	13	nC
$Q_{gs}$	Gate-Source Charge		-	3.8	-	
$Q_{gd}$	Gate-Drain Charge		-	5.2	-	

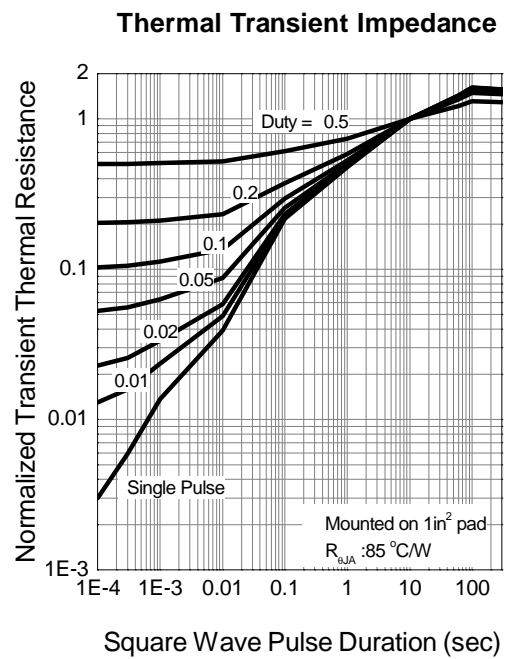
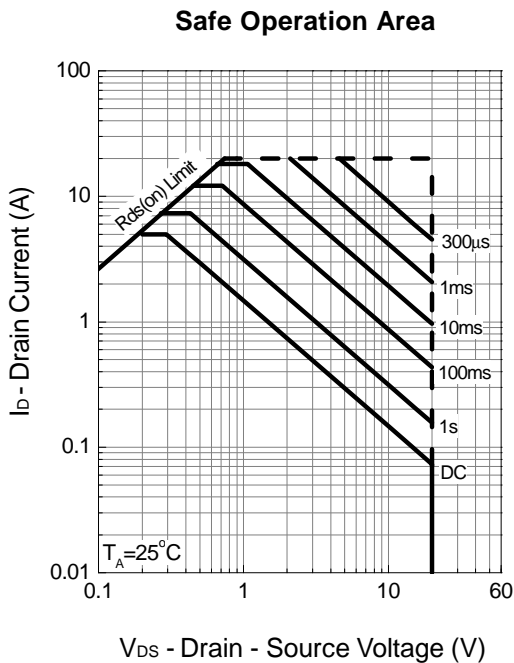
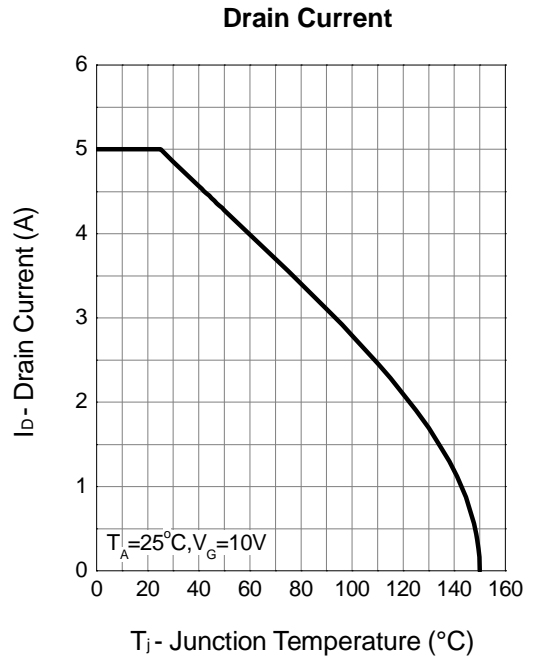
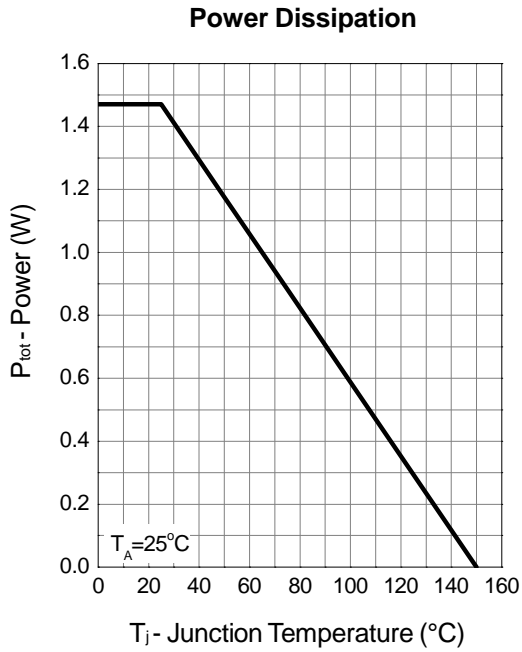
## Electrical Characteristics (Cont.) ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Test Conditions	APM2054NV			Unit
			Min.	Typ.	Max.	
<b>DYNAMIC CHARACTERISTICS<sup>b</sup></b>						
$t_{d(ON)}$	Turn-On Delay Time	$V_{DD}=10V, R_L=10\Omega,$ $I_{DS}=1A, V_{GEN}=4.5V,$ $R_G=6\Omega$	-	7	10	ns
$T_r$	Turn-On Rise Time		-	15	25	
$t_{d(OFF)}$	Turn-Off Delay Time		-	19	26	
$T_f$	Turn-Off Fall Time		-	6	7	
$R_G$	Gate Resistance	$V_{GS}=0V, V_{DS}=0V, F=1\text{MHz}$	-	2.5	-	$\Omega$
$C_{iss}$	Input Capacitance	$V_{GS}=0V,$ $V_{DS}=20V,$ Frequency=1.0MHz	-	450	-	pF
$C_{oss}$	Output Capacitance		-	100	-	
$C_{rss}$	Reverse Transfer Capacitance		-	60	-	

Note a : Pulse test ; pulse width $\leq 300\mu\text{s}$ , duty cycle $\leq 2\%$ .

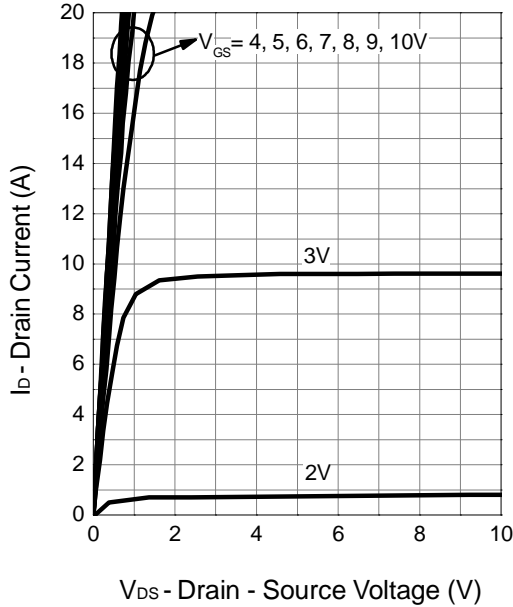
Note b : Guaranteed by design, not subject to production testing.

### Typical Operating Characteristics

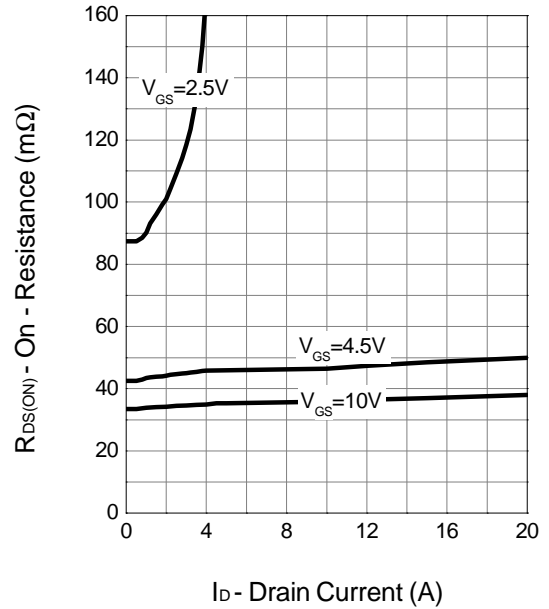


Typical Operating Characteristics (Cont.)

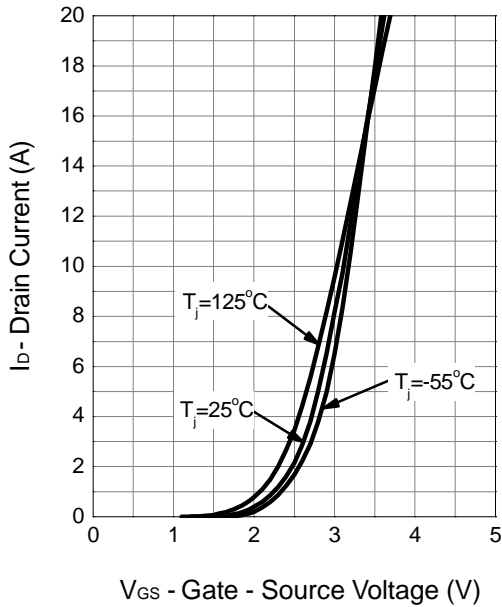
Output Characteristics



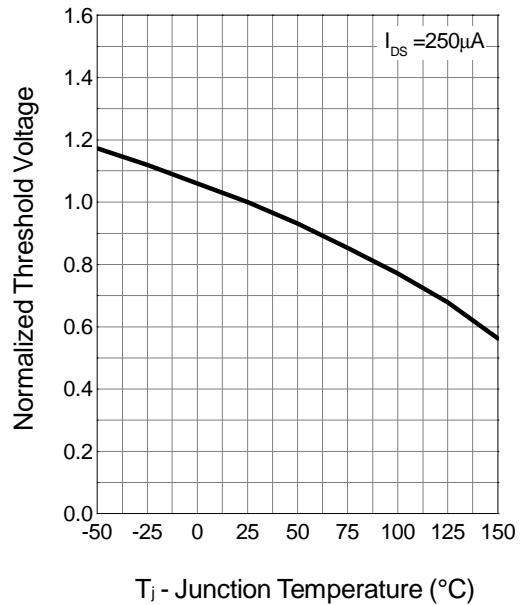
Drain-Source On Resistance



Transfer Characteristics

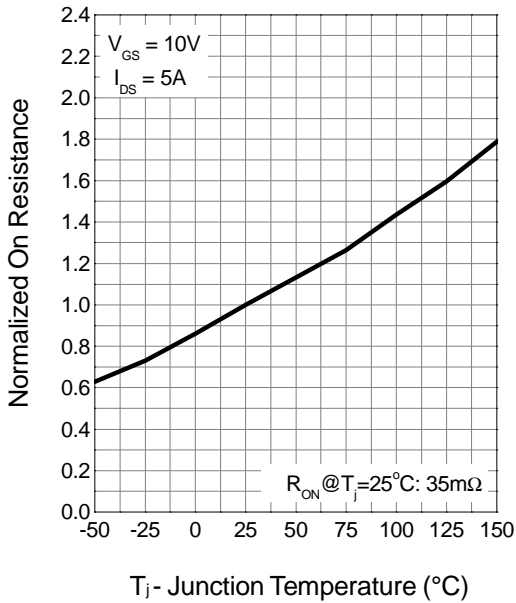


Gate Threshold Voltage

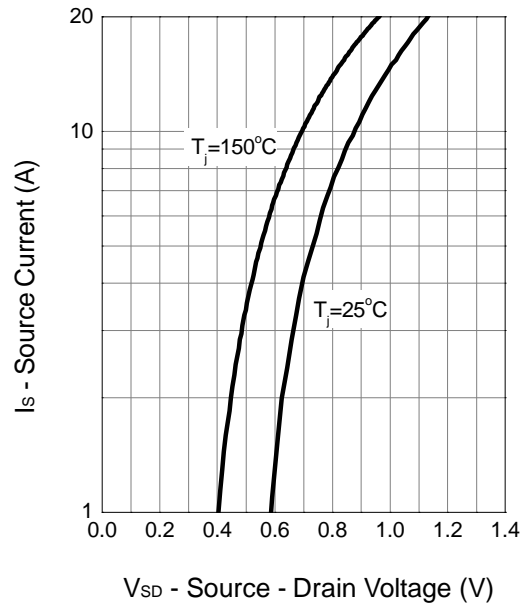


Typical Operating Characteristics (Cont.)

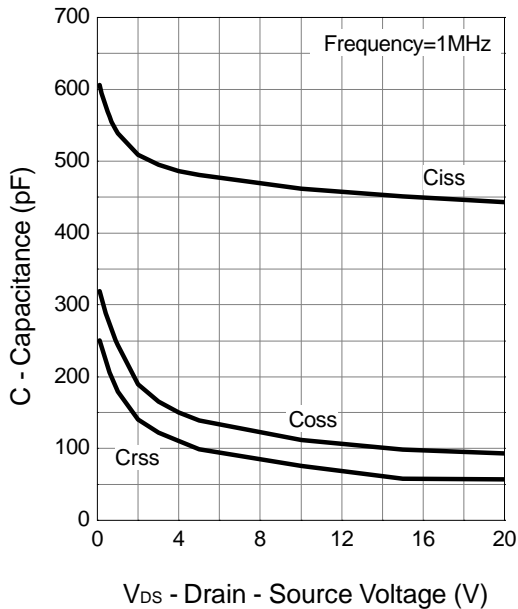
Drain-Source On Resistance



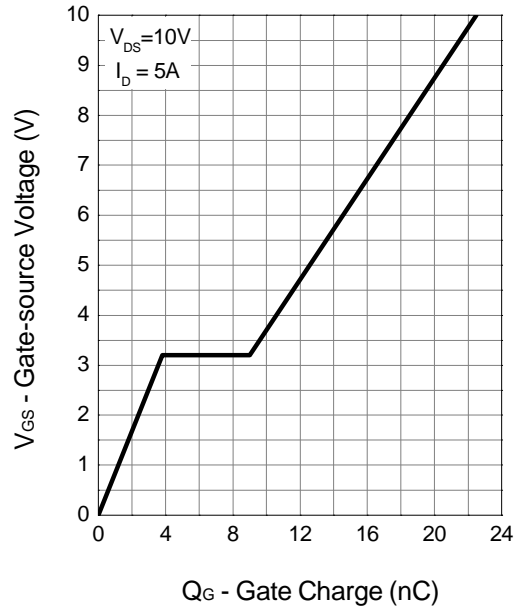
Source-Drain Diode Forward



Capacitance

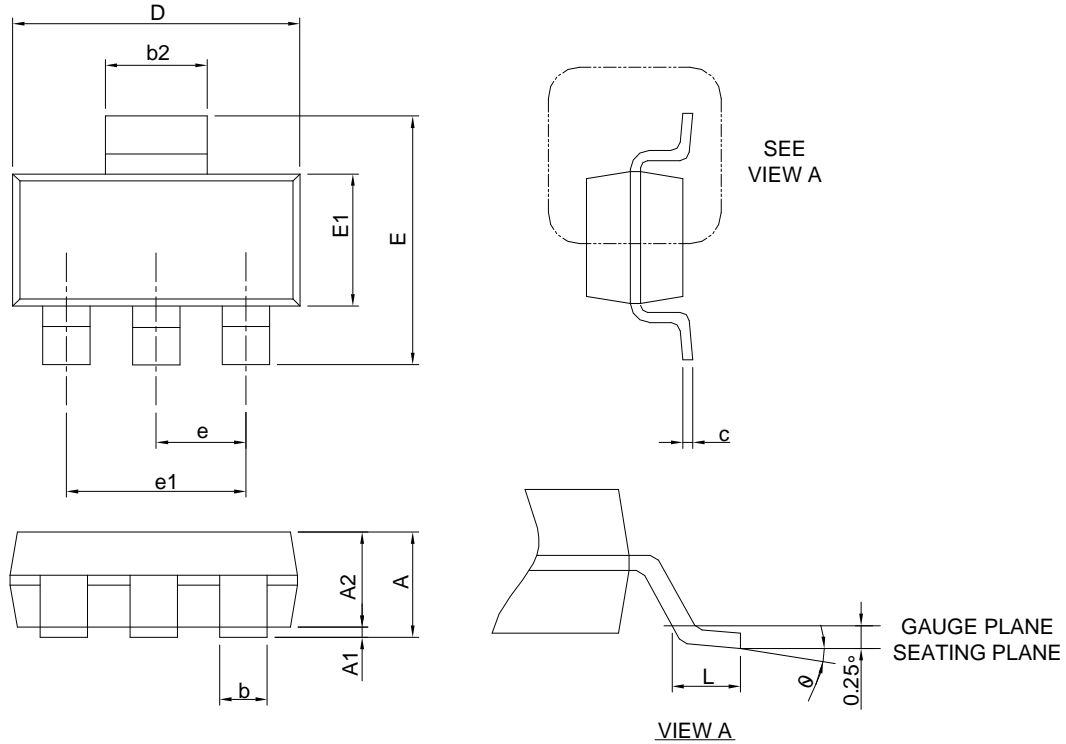


Gate Charge



Package Information

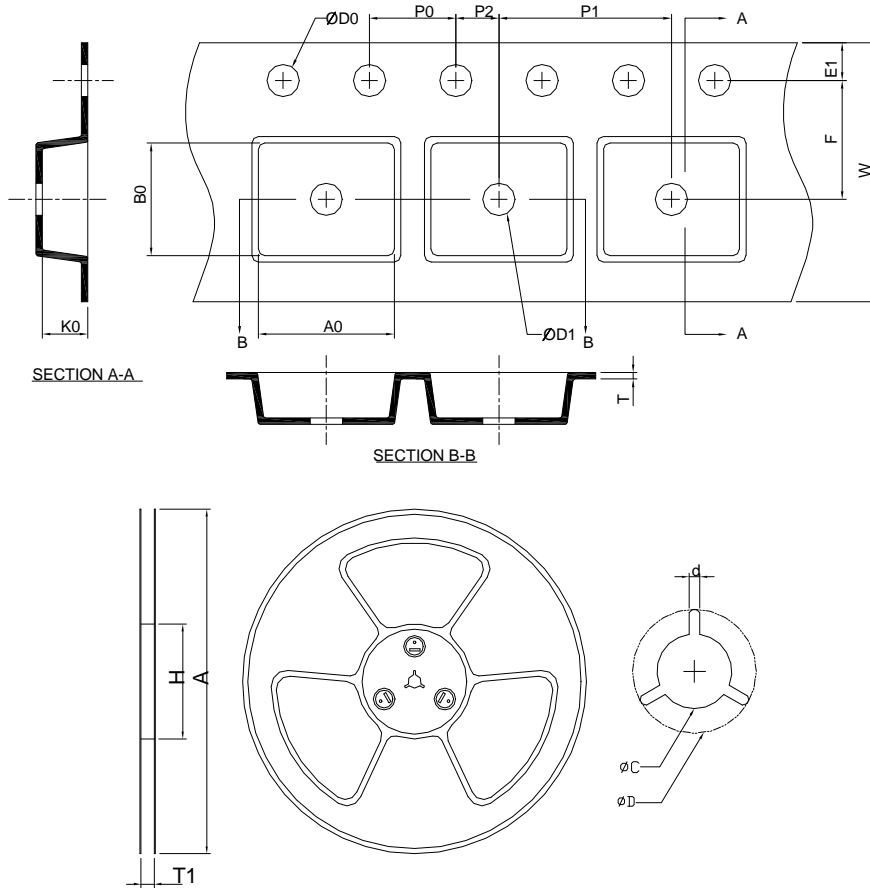
SOT-223



SYMBOL	SOT-223			
	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
A		1.80		0.071
A1	0.02	0.10	0.001	0.004
A2	1.50	1.70	0.059	0.067
b	0.66	0.84	0.026	0.033
b2	2.90	3.10	0.114	0.122
c	0.23	0.33	0.009	0.013
D	6.30	6.70	0.248	0.264
E	6.70	7.30	0.264	0.287
E1	3.30	3.70	0.130	0.146
e	2.30 BSC		0.091 BSC	
e1	4.60 BSC		0.181 BSC	
L	0.75		0.030	
θ	0°	10°	0°	10°

Note : 1. Follow from JEDEC TO-261 AA.  
 2. Dimension D and E1 are determined at the outermost extremes of the plastic exclusive of mold flash, tie bar burrs, gate burrs, and interlead flash, but including any mismatch between the top and bottom of the plastic body.

Carrier Tape & Reel Dimensions



Application	A	H	T1	C	d	D	W	E1	F
SOT-223	320.0 ±2.00	50 MIN.	12.4+2.00 -0.00	13.0+0.50 -0.20	1.5 MIN.	20.2 MIN.	12.00 ±0.30	1.75 ±0.10	5.50 ±0.05
	<b>P0</b>	<b>P1</b>	<b>P2</b>	<b>D0</b>	<b>D1</b>	<b>T</b>	<b>A0</b>	<b>B0</b>	<b>K0</b>
	4.00 ±0.10	8.00 ±0.10	2.00 ±0.50	1.5+0.10 -0.00	1.5 MIN.	0.6+0.00 -0.40	6.90 ±0.20	7.50 ±0.20	2.10 ±0.20

(mm)

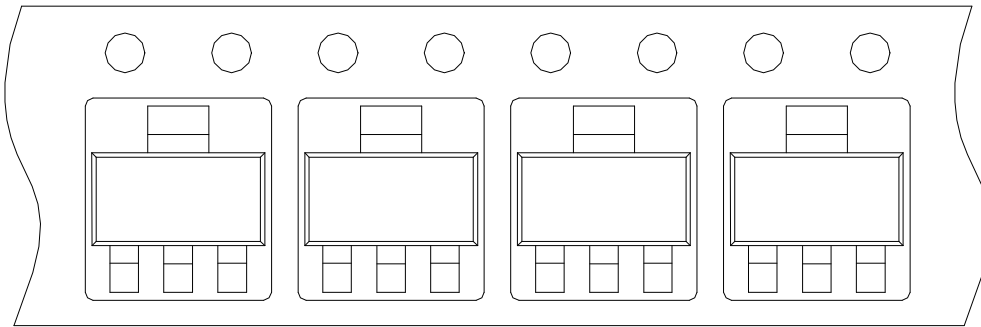
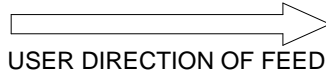
Devices Per Unit

Package Type	Unit	Quantity
SOT-223	Tape & Reel	2500

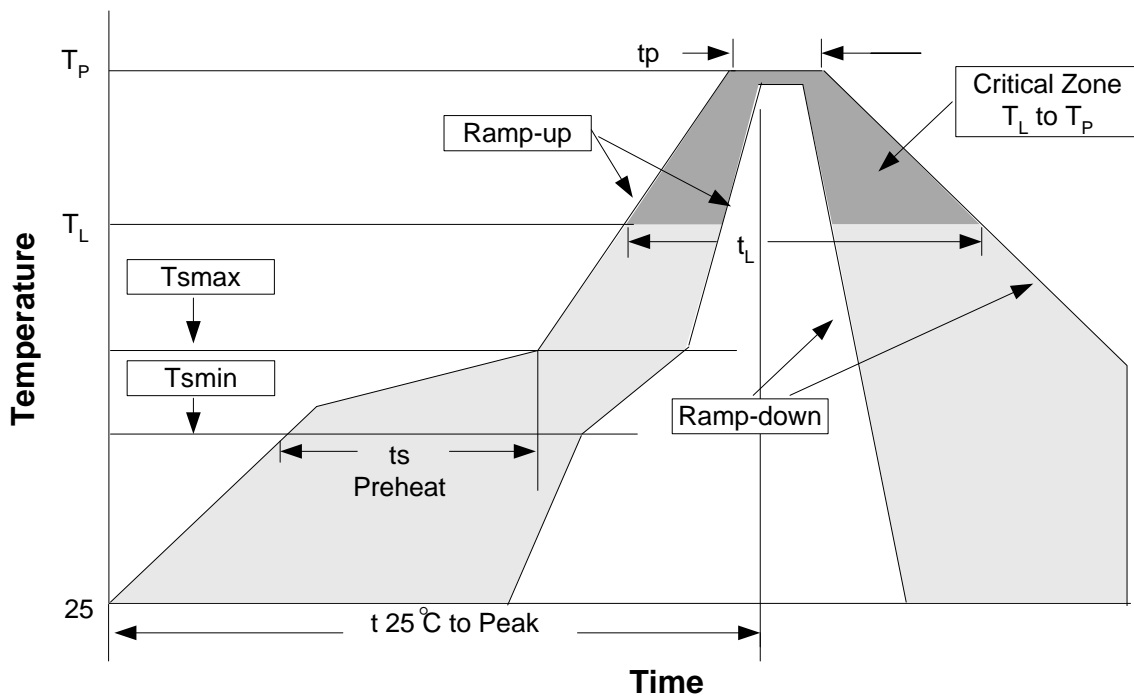


## Taping Direction Information

SOT-223



## Reflow Condition (IR/Convection or VPR Reflow)



## Reliability Test Program

Test item	Method	Description
SOLDERABILITY	MIL-STD-883D-2003	245°C, 5 sec
HOLT	MIL-STD-883D-1005.7	1000 Hrs Bias @125°C
PCT	JESD-22-B, A102	168 Hrs, 100%RH, 121°C
TST	MIL-STD-883D-1011.9	-65°C~150°C, 200 Cycles

## Classification Reflow Profiles

Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Average ramp-up rate (T <sub>L</sub> to T <sub>P</sub> )	3°C/second max.	3°C/second max.
Preheat - Temperature Min (T <sub>smin</sub> ) - Temperature Max (T <sub>smax</sub> ) - Time (min to max) (t <sub>s</sub> )	100°C 150°C 60-120 seconds	150°C 200°C 60-180 seconds
Time maintained above: - Temperature (T <sub>L</sub> ) - Time (t <sub>L</sub> )	183°C 60-150 seconds	217°C 60-150 seconds
Peak/Classification Temperature (T <sub>p</sub> )	See table 1	See table 2
Time within 5°C of actual Peak Temperature (t <sub>p</sub> )	10-30 seconds	20-40 seconds
Ramp-down Rate	6°C/second max.	6°C/second max.
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.

Note: All temperatures refer to topside of the package. Measured on the body surface.

Table 1. SnPb Eutectic Process – Package Peak Reflow Temperatures

Package Thickness	Volume mm <sup>3</sup> <350	Volume mm <sup>3</sup> ≈350
<2.5 mm	240 +0/-5°C	225 +0/-5°C
≥2.5 mm	225 +0/-5°C	225 +0/-5°C

Table 2. Pb-free Process – Package Classification Reflow Temperatures

Package Thickness	Volume mm <sup>3</sup> <350	Volume mm <sup>3</sup> 350-2000	Volume mm <sup>3</sup> >2000
<1.6 mm	260 +0°C*	260 +0°C*	260 +0°C*
1.6 mm – 2.5 mm	260 +0°C*	250 +0°C*	245 +0°C*
≥2.5 mm	250 +0°C*	245 +0°C*	245 +0°C*

\*Tolerance: The device manufacturer/supplier **shall** assure process compatibility up to and including the stated classification temperature (this means Peak reflow temperature +0°C. For example 260°C+0°C) at the rated MSL level.

## Customer Service

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